

# SN54ABT16501, SN74ABT16501 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS086B – FEBRUARY 1991 – REVISED JULY 1994

- **Members of the Texas Instruments Widebus™ Family**
- **State-of-the-Art EPIC-II B™ BiCMOS Design Significantly Reduces Power Dissipation**
- **UBT™ (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, or Clocked Mode**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)**
- **Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17**
- **Typical  $V_{OLP}$  (Output Ground Bounce) < 0.8 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

## description

These 18-bit universal bus transceivers consist of storage elements that can operate either as D-type latches or D-type flip-flops to allow data flow in transparent or clocked modes.

Data flow in each direction is controlled by output-enable (OEAB and  $\overline{\text{OEBA}}$ ), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A bus data is stored in the latch/flip-flop on the low-to-high transition of CLKAB. When OEAB is high, the outputs are active. When OEAB is low, the outputs are in the high-impedance state.

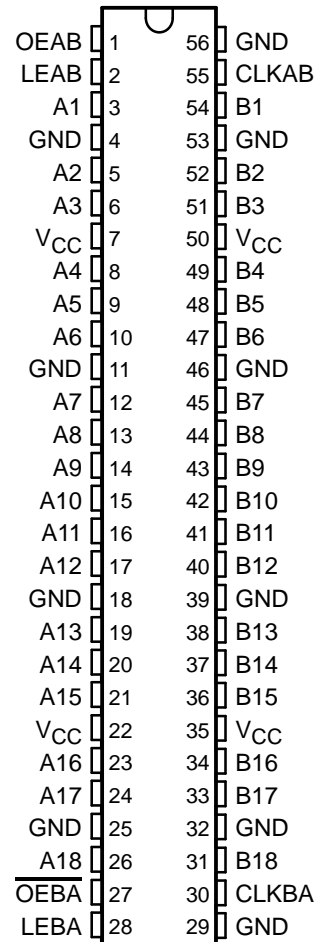
Data flow for B to A is similar to that of A to B but uses  $\overline{\text{OEBA}}$ , LEBA, and CLKBA. The output enables are complementary (OEAB is active high and  $\overline{\text{OEBA}}$  is active low).

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The SN74ABT16501 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT16501 is characterized over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ABT16501 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

SN54ABT16501 . . . WD PACKAGE  
SN74ABT16501 . . . DGG OR DL PACKAGE  
(TOP VIEW)



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# SN54ABT16501, SN74ABT16501

## 18-BIT UNIVERSAL BUS TRANSCEIVERS

### WITH 3-STATE OUTPUTS

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FUNCTION TABLE†

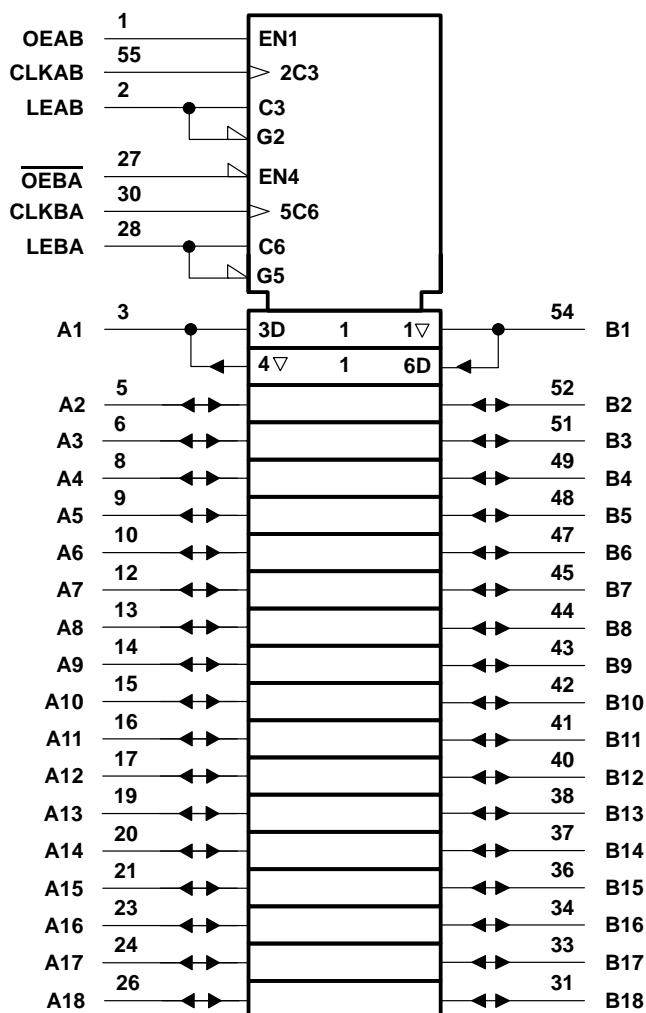
INPUTS				OUTPUT B
OEAB	LEAB	CLKAB	A	
L	X	X	X	Z
H	H	X	L	L
H	H	X	H	H
H	L	↑	L	L
H	L	↑	H	H
H	L	H	X	B <sub>0</sub> ‡
H	L	L	X	B <sub>0</sub> §

† A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, and CLKBA.

‡ Output level before the indicated steady-state input conditions were established, provided that CLKAB was high before LEAB went low.

§ Output level before the indicated steady-state input conditions were established.

logic symbol¶



¶ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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The diagram illustrates a 17-channel multiplexer system. It features 17 input channels on the left, each connected to a 1D C1 multiplexer block. The inputs are labeled as follows: OEAB (1), CLKAB (55), LEAB (2), LEBA (28), CLKBA (30), OEBA (27), and A1 (3). The outputs of these blocks are connected to a central 1D C1 multiplexer block, which is then connected to the output channels (B1). The diagram also shows a feedback loop from the output channels back to the input channels. A bracket at the bottom indicates that the system is part of a larger 17-channel multiplexer system.

Supply voltage range, $V_{CC}$	.....	-0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1)	.....	-0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, $V_O$	.....	-0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABT16501	.....	96 mA
SN74ABT16501	.....	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	.....	-18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	.....	-50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DGG package	.....	1 W
DL package	.....	1.4 W
Storage temperature range	.....	-65°C to 150°C

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 ABT Advanced BiCMOS Technology Data Book, literature number SCBD002B.

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#### recommended operating conditions (see Note 3)

			SN54ABT16501		SN74ABT16501		UNIT
			MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage		4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage		2		2		V
$V_{IL}$	Low-level input voltage			0.8		0.8	V
$V_I$	Input voltage		0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current			–24		–32	mA
$I_{OL}$	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$T_A$	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused or floating pins (input or I/O) must be held high or low.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	$T_A = 25^\circ\text{C}$			SN54ABT16501		SN74ABT16501		UNIT
			MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
$V_{IK}$		$V_{CC} = 4.5\text{ V}$ , $I_I = -18\text{ mA}$			–1.2		–1.2		–1.2	V
$V_{OH}$		$V_{CC} = 4.5\text{ V}$ , $I_{OH} = -3\text{ mA}$	2.5			2.5		2.5		V
		$V_{CC} = 5\text{ V}$ , $I_{OH} = -3\text{ mA}$	3			3		3		
		$V_{CC} = 4.5\text{ V}$ , $I_{OH} = -24\text{ mA}$	2			2				
		$V_{CC} = 4.5\text{ V}$ , $I_{OH} = -32\text{ mA}$	2*					2		
$V_{OL}$		$V_{CC} = 4.5\text{ V}$ , $I_{OL} = 48\text{ mA}$			0.55		0.55			V
		$V_{CC} = 4.5\text{ V}$ , $I_{OL} = 64\text{ mA}$			0.55*				0.55	
$I_I$	Control inputs	$V_{CC} = 5.5\text{ V}$ , $V_I = V_{CC}$ or GND			$\pm 1$		$\pm 1$		$\pm 1$	$\mu\text{A}$
	A or B ports				$\pm 100$		$\pm 100$		$\pm 100$	
$I_{OZH}^\ddagger$		$V_{CC} = 5.5\text{ V}$ , $V_O = 2.7\text{ V}$			50		50		50	$\mu\text{A}$
$I_{OZL}^\ddagger$		$V_{CC} = 5.5\text{ V}$ , $V_O = 0.5\text{ V}$			–50		–50		–50	$\mu\text{A}$
$I_{off}$		$V_{CC} = 0$ , $V_I$ or $V_O \leq 4.5\text{ V}$			$\pm 100$				$\pm 100$	$\mu\text{A}$
$I_{CEX}$	Outputs high	$V_{CC} = 5.5\text{ V}$ , $V_O = 5.5\text{ V}$			50		50		50	$\mu\text{A}$
$I_O^\S$		$V_{CC} = 5.5\text{ V}$ , $V_O = 2.5\text{ V}$	–50	–100	–180	–50	–180	–50	–180	mA
$I_{CC}$	A or B ports	$V_{CC} = 5.5\text{ V}$ , $I_O = 0$ , $V_I = V_{CC}$ or GND			3		5		3	mA
		Outputs high			76		76		76	
		Outputs disabled			3.3		5.3		3.3	
$\Delta I_{CC}^\P$	Control inputs	$V_{CC} = 5.5\text{ V}$ , One input at 3.4 V, Other inputs at $V_{CC}$ or GND			5		6		5	mA
	A or B ports				1.5		1.5		1.5	
$C_i$	Control inputs	$V_I = 2.5\text{ V}$ or $0.5\text{ V}$			4					pF
$C_{io}$	A or B ports	$V_O = 2.5\text{ V}$ or $0.5\text{ V}$			8					pF

\* On products compliant to MIL-STD-883, Class B, this parameter does not apply.

† All typical values are at  $V_{CC} = 5\text{ V}$ .

‡ The parameters  $I_{OZH}$  and  $I_{OZL}$  include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			SN54ABT16501		SN74ABT16501		UNIT
			MIN	MAX	MIN	MAX	
$f_{\text{clock}}$	Clock frequency, CLKAB or CLKBA		0	105	0	105	MHz
$t_w^\dagger$	Pulse duration	LEAB or LEBA high	3.3		3.3		ns
		CLKAB or CLKBA high or low	4.7		4.7		
$t_{\text{su}}$	Setup time	A before CLKAB $\uparrow$ or B before CLKBA $\uparrow$	4		3.5		ns
		A before LEAB $\downarrow$ or B before LEBA $\downarrow$	4		4		
			1.5		1.5		
$t_h$	Hold time	A after CLKAB $\uparrow$ or B after CLKBA $\uparrow$	1		1		ns
		A after LEAB $\downarrow$ or B after LEBA $\downarrow$	2.5		2.5		

$^\dagger$  This parameter is specified by design but not tested.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$			SN54ABT16501		SN74ABT16501		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\text{max}}$	CLKAB or CLKBA		105	160		105		105		MHz
$t_{\text{PLH}}$	A or B	B or A	1	2.6	3.4	1	3.9	1	3.7	ns
$t_{\text{PHL}}$			1	2.6	3.4	1	4.1	1	4	
$t_{\text{PLH}}$	LEAB or LEBA	B or A	1.3	3.3	4.3	1.3	5.4	1.3	5.1	ns
$t_{\text{PHL}}$			1.4	3.1	4.1	1.4	4.6	1.4	4.4	
$t_{\text{PLH}}$	CLKAB or CLKBA	B or A	1.5	3.5	4.5	1.5	5.3	1.5	5	ns
$t_{\text{PHL}}$			1.3	3.1	4.1	1.3	4.6	1.3	4.4	
$t_{\text{PZH}}$	OEAB or $\overline{\text{OEBA}}$	B or A	1	3	4	1	4.8	1	4.7	ns
$t_{\text{PZL}}$			2.6	4.9	5.9	2.6	6.6	2.6	6.5	
$t_{\text{PHZ}}$	OEAB or $\overline{\text{OEBA}}$	B or A	1.6	3.9	4.9	1.6	5.9	1.6	5.8	ns
$t_{\text{PLZ}}$			1.1	3.4	4.4	1.1	5.1	1.1	4.9	

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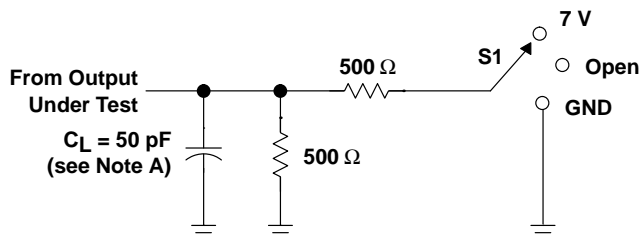
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### WITH 3-STATE OUTPUTS

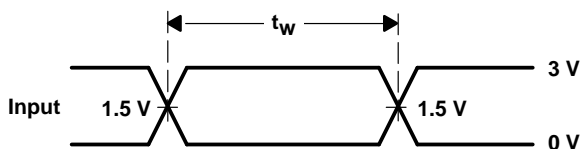
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#### PARAMETER MEASUREMENT INFORMATION

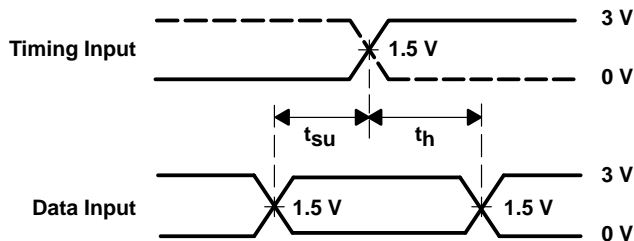


LOAD CIRCUIT FOR OUTPUTS

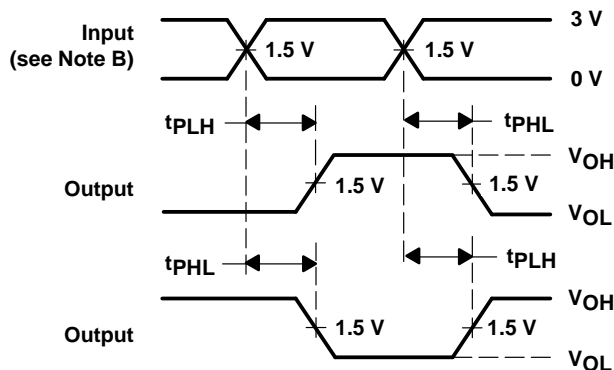
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



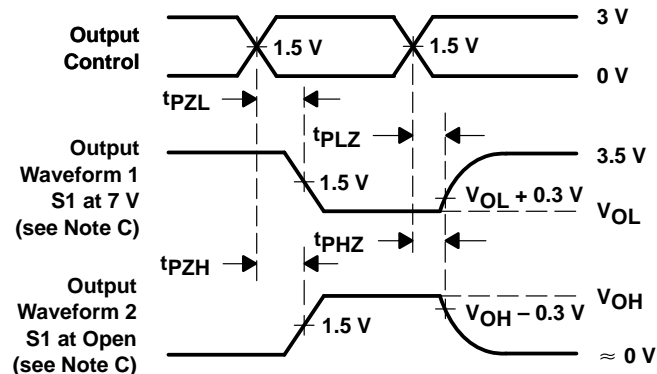
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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